# International Rectifier

# POWER MOSFET THRU-HOLE (TO-257AA)

# IRFY240,IRFY240M 200V, N-CHANNEL HEXFET® MOSFET TECHNOLOGY

#### **Product Summary**

Part Number	RDS(on)	ΙD	Eyelets		
IRFY240	0.18 Ω	16A	Glass		
IRFY240M	0.18 Ω	16A	Glass		

HEXFET® MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.



#### Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Glass Eyelets
- For Space Level Applications Refer to Ceramic Version Part Numbers IRFY240C, IRFY240CM

## **Absolute Maximum Ratings**

9							
	Parameter		Units				
ID @ VGS = 10V, TC = 25°C	Continuous Drain Current	16					
ID @ VGS = 10V, TC = 100°C	Continuous Drain Current	10.2	Α				
I <sub>DM</sub>	Pulsed Drain Current ①	64					
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Max. Power Dissipation	100	W				
	Linear Derating Factor	0.8	W/°C				
VGS	Gate-to-Source Voltage	±20	V				
EAS	Single Pulse Avalanche Energy ②	580	mJ				
IAR	Avalanche Current ①	16	Α				
EAR	Repetitive Avalanche Energy ①	10	mJ				
dv/dt	Peak Diode Recovery dv/dt 3	5.0	V/ns				
TJ	Operating Junction	-55 to 150					
√ TSTG	Storage Temperature Range		°C				
找了PDF	Lead Temperature	300(0.063in./1.6mm from case for 10 sec)					
A SECTION	Weight	3.3 (Typical)	g				

For footnotes refer to the last page

# Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min	Тур	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	200	_	_	V	VGS = 0V, ID = 1.0mA
ΔBVDSS/ΔTJ	Temperature Coefficient of Breakdown Voltage	_	0.29	_	V/°C	Reference to 25°C, I <sub>D</sub> = 1.0mA
RDS(on)	Static Drain-to-Source On-State Resistance	_	_	0.18	Ω	VGS = 10V, ID = 10.2A $_{\oplus}$
VGS(th)	Gate Threshold Voltage	2.0	_	4.0	V	$VDS = VGS$ , $ID = 250\mu A$
9fs	Forward Transconductance	6.1	_	_	S (7)	$V_{DS} > 15V$ , $I_{DS} = 10.2A$ $\oplus$
IDSS	Zero Gate Voltage Drain Current		_	25	μА	VDS= 160V ,VGS=0V
		_	_	250	μΑ	VDS = 160V,
						$V_{GS} = 0V$ , $T_{J} = 125$ °C
IGSS	Gate-to-Source Leakage Forward	_	_	100	nA	VGS = 20V
IGSS	Gate-to-Source Leakage Reverse	_	_	-100	nA	VGS = -20V
Qg	Total Gate Charge	_	_	60		VGS =10V, ID = 16A
Qgs	Gate-to-Source Charge	_	_	10.6	nC	VDS = 50V
Qgd	Gate-to-Drain ('Miller') Charge		_	37.6		
td(on)	Turn-On Delay Time	_	_	20		$V_{DD} = 100V, I_{D} = 16A,$
tr	Rise Time	_	_	152	20	$RG = 9.1\Omega$
td(off)	Turn-Off Delay Time	_	_	58	ns	
tf	Fall Time		_	67		
LS+LD	Total Inductance	_	6.8	_	nΗ	Measured from drain lead (6mm/0.25in. from
						package) to source lead (6mm/0.25in. from package)
Ciss	Input Capacitance	_	1300	_		VGS = 0V, VDS = 25V
Coss	Output Capacitance		400	_	pF	f = 1.0MHz
C <sub>rss</sub>	Reverse Transfer Capacitance		130	_		

# **Source-Drain Diode Ratings and Characteristics**

	Parameter	Min	Тур	Max	Units	Test Conditions
Is	Continuous Source Current (Body Diode)	_	_	16	۸	
ISM	Pulse Source Current (Body Diode) ①		_	64	Α	
VSD	Diode Forward Voltage		_	1.5	V	Tj = 25°C, IS = 16A, VGS = 0V ④
t <sub>rr</sub>	Reverse Recovery Time		_	500	nS	Tj = 25°C, Iϝ = 16A, di/dt ≤ 100A/μs
QRR	Reverse Recovery Charge	_	_	5.3	μC	V <sub>DD</sub> ≤ 50V ④
ton	Forward Turn-On Time Intrinsic turn-on	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by LS + LD.				

### **Thermal Resistance**

	Parameter	Min	Тур	Max	Units	Test Conditions
R <sub>th</sub> JC	Junction-to-Case	_	_	1.25		
RthCS	Case-to-sink	_	0.21		°C/W	
RthJA	Junction-to-Ambient	_	_	80		Typical socket mount

Note: Corresponding Spice and Saber models are available on the G&S Website.

For footnotes refer to the last name

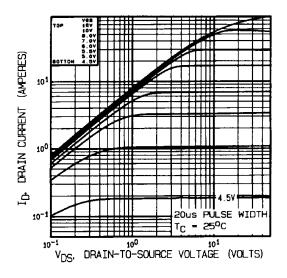


Fig 1. Typical Output Characteristics

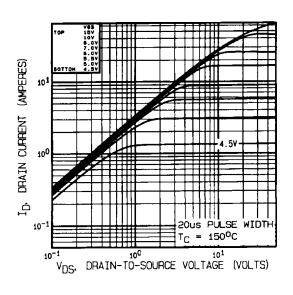


Fig 2. Typical Output Characteristics

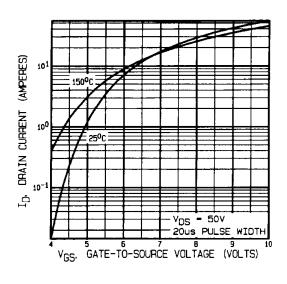
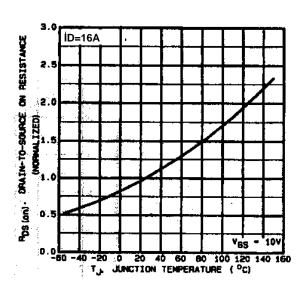
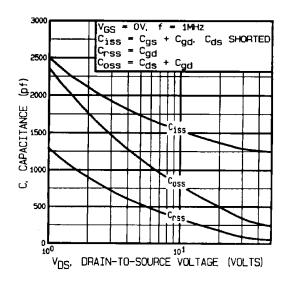


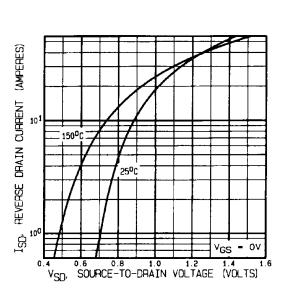
Fig 3. Typical Transfer Characteristics



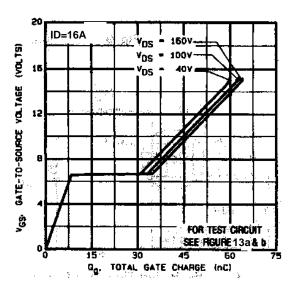
**Fig 4.** Normalized On-Resistance Vs. Temperature



**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



**Fig 7.** Typical Source-Drain Diode Forward Voltage



**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage

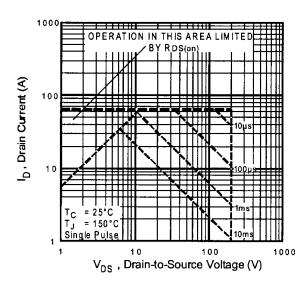
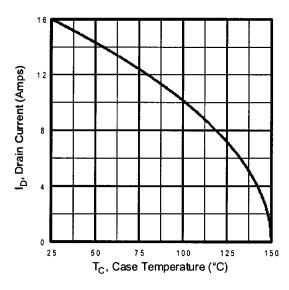


Fig 8. Maximum Safe Operating Area



**Fig 9.** Maximum Drain Current Vs. Case Temperature

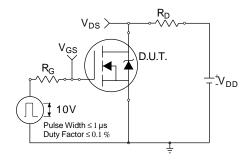


Fig 10a. Switching Time Test Circuit

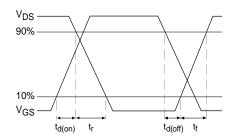


Fig 10b. Switching Time Waveforms

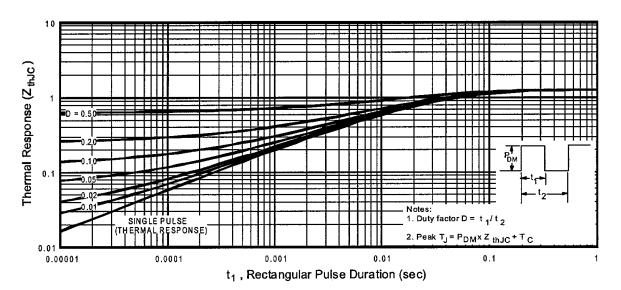


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

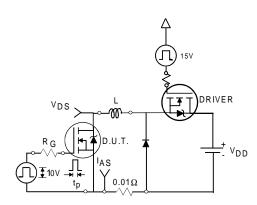


Fig 12a. Unclamped Inductive Test Circuit

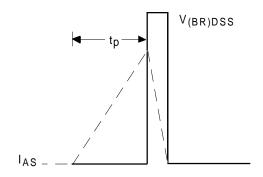


Fig 12b. Unclamped Inductive Waveforms

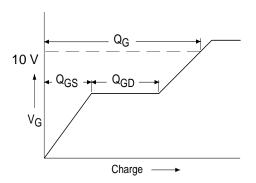


Fig 13a. Basic Gate Charge Waveform

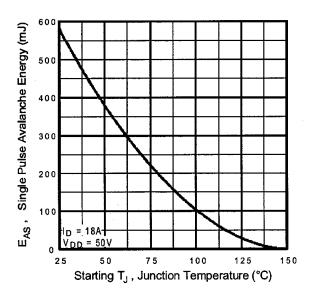


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

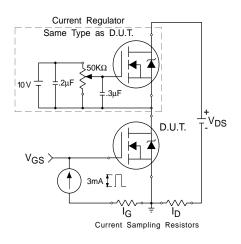


Fig 13b. Gate Charge Test Circuit

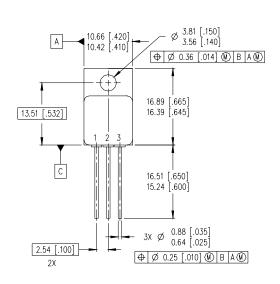
# International TOR Rectifier

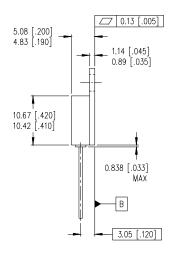
#### Footnotes:

- Repetitive Rating; Pulse width limited by maximum junction temperature.
- V<sub>DD</sub> = 50V, starting T<sub>J</sub> = 25°C, L= 4.5mH Peak I<sub>L</sub> = 16A, V<sub>GS</sub> = 10V

- $\label{eq:local_local_state} \begin{array}{ll} \text{(3)} & I_{SD} \leq 16\text{A, di/dt} \leq 150\text{A/}\mu\text{s,} \\ & V_{DD} \leq 200\text{V, T}_{J} \leq 150^{\circ}\text{C} \\ \end{array}$
- 4 Pulse width  $\leq 300 \ \mu s$ ; Duty Cycle  $\leq 2\%$

#### Case Outline and Dimensions — TO-257AA



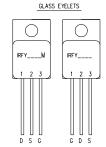


#### NOTES:

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1994.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-257AA.

<u>LEGEND</u>
D - DRAIN
S - SOURCE

G - GATE





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